

# 4:1 High-Speed USB Multiplexer/Switch

## FSUSB74

### Description

The FSUSB74 is a Bi-directional, Low-Power, High-Speed USB 2.0 4:1 MUX. It is Optimized for Switching from four High-Speed (480Mbps) sources or any combination of High-Speed and full-/low-speed USB/UART sources to one USB 2.0 connector.

### Applications

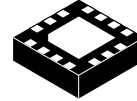
- MP3 Portable Media Players
- Cellular Phones, Smart Phones
- Netbooks, Mobile Internet Devices (MID)

### Related Resources

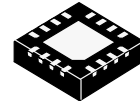
- FSUSB74 Demonstration Board
- FSUSB74 Evaluation Board

### Features

Switch Type	4:1
USB	USB 2.0 High-Speed Compliant USB 2.0 Full-Speed Compliant
R <sub>ON</sub>	6.5 Ω
C <sub>ON</sub>	7.5 pF
ESD (IEC61000-4-2)	15 kV (Air) 8 kV (Contact)
V <sub>CC</sub>	2.7 to 4.4 V
I <sub>CCSLP</sub>	<1 μA
I <sub>CCACT</sub>	9 μA
Package	16-Lead UMLP 1.80 x 2.60 x 0.55mm, 0.40mm Pitch 16-Lead MLP 3 x 3 x 0.7mm, 0.5mm Pitch
Ordering Information	FSUSB74UMX (UMLP) FSUSB74MPX (MLP)

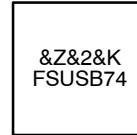


WQFN 16 3X3, 0.5P  
CASE 510BS



UQFN 16 1.8X2.6, 0.6P  
CASE 523BF

### MARKING DIAGRAM



LC,FSUSB74 = Device Code  
 &Z = Assembly Plant Code  
 &2 = 2-Digit Date Code  
 &K = 2-Digits Lot Run Lot Traceability Code  
 FSUSB74 = Specific Device Code

### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
FSUSB74MPX	WQFN-16 (Pb-Free)	3000 / Tape & Reel
FSUSB74UMX	UQFN-16 (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

# FSUSB74

## TYPICAL APPLICATION

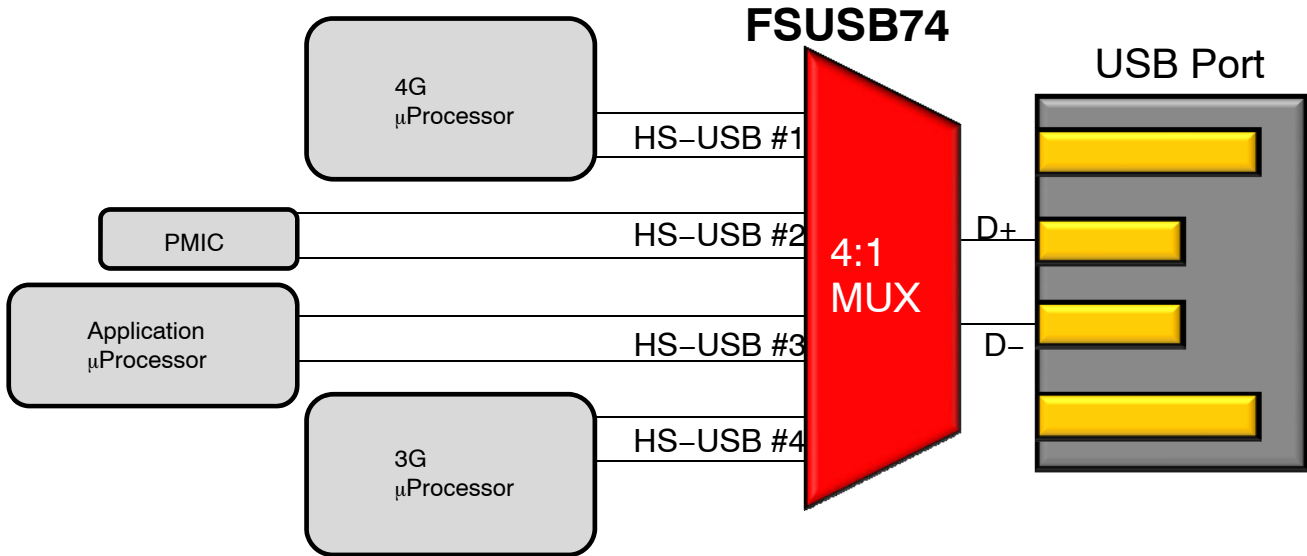


Figure 1. Mobile Phone Example

## PIN CONFIGURATIONS

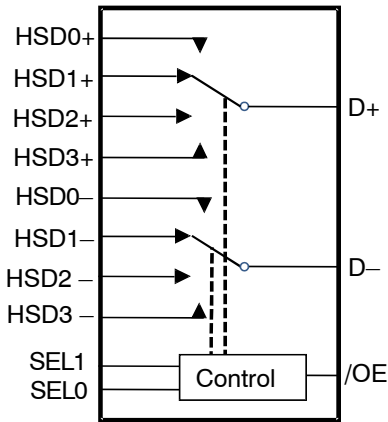


Figure 2. UMLP Analog Symbol

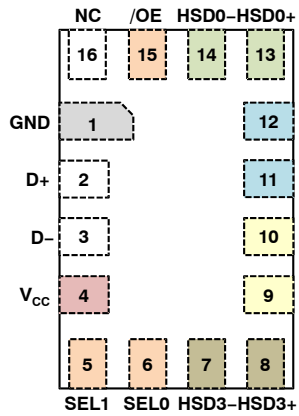


Figure 3. UMLP (Top View)

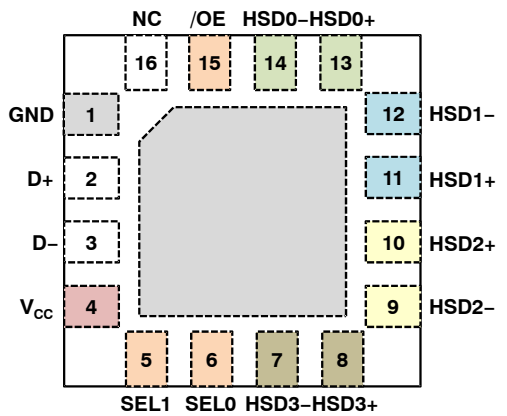


Figure 4. MLP (Top View)

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## PIN DESCRIPTIONS

Pin No.	Name	Type	Description
1	GND	Ground	Ground
2	D+	I/O	D+ common port (HS or FS USB)
3	D-	I/O	D- common port (HS or FS USB)
4	V <sub>CC</sub>	Power Supply	Supply Voltage
5	SEL1	Input	Path Selection Control Input (see truth table below)
6	SEL0	Input	Path Selection Control Input (see truth table below)
7	HSD3-	I/O	D- from fourth source path (HS or FS USB)
8	HSD3+	I/O	D+ from fourth source path (HS or FS USB)
9	HSD2-	I/O	D- from third source path (HS or FS USB)
10	HSD2+	I/O	D+ from third source path (HS or FS USB)
11	HSD1+	I/O	D+ from second source path (HS or FS USB)
12	HSD1-	I/O	D- from second source path (HS or FS USB)
13	HSD0+	I/O	D+ from first source path (HS or FS USB)
14	HSD0-	I/O	D- from first source path (HS or FS USB)
15	/OE	Input	D- from first source path (HS or FS USB)
16	NC	-	No Connect

## TRUTH TABLE

/OE	SEL1	SEL0	Function
1	X	X	D+, D- Switch Paths Open
0	0	0	D+ = HSD0+, D- = HSD0-
0	0	1	D+ = HSD1+, D- = HSD1-
0	1	0	D+ = HSD2+, D- = HSD2-
0	1	1	D+ = HSD3+, D- = HSD3-

## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Min.	Max.	Unit	
V <sub>CC</sub>	Supply Voltage	-0.5	5.25	V	
V <sub>CNTRL</sub>	DC Input Voltage (SEL1, SEL0, /OE, SELS) <sup>(1)</sup>	-0.50	V <sub>CC</sub>	V	
V <sub>SW</sub>	DC Switch I/O Voltage <sup>(1)</sup>	-0.50	5.25	V	
I <sub>IK</sub>	DC Input Diode Current	-50	-	mA	
T <sub>STG</sub>	Storage Temperature	-65	+150	°C	
MSL	Moisture Sensitivity Level (JEDEC J-STD-020A)	-	1	Level	
ESD	IEC61000-4-2 System on USB connector pins D+ & D-	Air Gap	15	-	kV
		Contact	8	-	
	Human Body Model, JEDEC: JESD22-A114	D+,D- to GND	6	-	
		Power to GND	12	-	
		All Other Pins	2	-	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

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## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min.	Max.	Unit
$V_{CC}$	Supply Voltage	2.5	4.4	V
$V_{CNTRL}$ (Note 2)	Control Input Voltage (SEL1, SEL0, /OE, and SELS)	0	$V_{CC}$	V
$V_{SW}$	Switch I/O Voltage	-0.5	4.4	V
$T_A$	Operating Temperature	-40	+85	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

2. The control input must be held HIGH or LOW; it must not float.

## DC ELECTRICAL CHARACTERISTICS (All typical values are for $V_{CC} = 3.3$ V at $25^\circ\text{C}$ unless otherwise specified.)

Symbol	Parameter	Test Conditions	$V_{CC}$ (V)	$T_A = -40^\circ\text{C to } 85^\circ\text{C}$			Unit
				Min.	Typ.	Max.	
$R_{ON}$ (Note 3)	HS Switch On Resistance	$V_{SW} = 0.4$ V, $I_{ON} = -8$ mA, Figure 5	3.3		6.5	9.0	$\Omega$
$\Delta R_{ON}$ (Note 3)	HS Delta Ron (Note 4)	$V_{SW} = 0.4$ V, $I_{ON} = -8$ mA	3.3		0.5	0.5	$\Omega$
$I_{IN}$	Control Input Leakage	All Combinations of /OE, SEL1 & SEL0 in the Truth Table ( $1 = V_{CC}$ , $0 = 0$ V)	4.4	-1	-	-	$\mu\text{A}$
$I_{OZ}$	Off State Leakage	$0 \leq D_n$ , HSD0n, HSD1n, HSD2n, HSD3n $\leq 4.4$ V	4.4	-1	-	-	$\mu\text{A}$
$I_{OFF}$	Power-Off Leakage Current (All I/O Ports)	$V_{SW} = 0$ V to 4.4 V, $V_{CC} = 0$ V, Figure 6	0	-1	-	-	$\mu\text{A}$
$I_{CCSLP}$	Sleep Mode Supply Current	/OE = $V_{CC}$	4.4	-	-	-	$\mu\text{A}$
$I_{CCACT}$	Active Mode Supply Current	All Active Modes in Truth Table	4.4	-	9	18	$\mu\text{A}$
$I_{CCT}$	Increase in $I_{CC}$ Current per Control Input and $V_{CC}$	$V_{CNTRL} = 1.8$ V	4.4	-	3.3	4.0	$\mu\text{A}$
		$V_{CNTRL} = 1.2$ V	4.4	-	4.9	6.0	$\mu\text{A}$
$V_{IK}$	Clamp Diode Voltage	$I_{IN} = -18$ mA	2.5	-	-	-1.2	V
$V_{IH}$	Control Input Voltage High	SEL1, SEL0, /OE	2.5 to 4.4	1.0	-	-	V
$V_{IL}$	Control Input Voltage Low	SEL1, SEL0, /OE	2.5 to 4.4	-	-	0.35	V

3. Measured by the voltage drop between HSDn and Dn pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the two (HSDn or Dn ports).

4. Guaranteed by characterization.

## AC ELECTRICAL CHARACTERISTICS (All typical values are for $V_{CC} = 3.3$ V at $T_A = 25^\circ\text{C}$ unless otherwise specified.)

Symbol	Parameter	Test Conditions	$V_{CC}$ (V)	$T_A = -40^\circ\text{C to } 85^\circ\text{C}$			Unit
				Min.	Typ.	Max.	
$t_{ON}$	Turn-On Time when Switching from One USB Path (or Disabled i.e. /OE=1) to Another USB Path	$R_L = 50$ $\Omega$ , $C_L = 35$ pF, $V_{SW} = 0.8$ V, Figure 7, Figure 8	2.5 to 4.4	126	-	400	$\mu\text{s}$
$t_{OFF}$	Turn-Off Time, Turning Off Any of the USB Paths	$R_L = 50$ $\Omega$ , $C_L = 35$ pF, $V_{SW} = 0.8$ V, Figure 7, Figure 8	2.5 to 4.4	-	-	80	ns
$t_{PD}$	Propagation Delay (Note 5)	$C_L = 5$ pF, $R_L = 50$ $\Omega$ , Figure 7, Figure 9	3.3	-	0.25	-	ns
$t_{RF}$	Slow Turn-On/Off Switch Paths (Note 5)	$C_L = 5$ pF, Dn at 0 V or 3.6 V, 40.5 $\Omega$ in series with switch 10% to 90%	3.3	-	4.5	-	ns
$t_{BBM}$	Break-Before-Make Time (Note 5)	$R_L = 50$ $\Omega$ , $C_L = 35$ pF, $V_{SW1} = V_{SW2} = 0.8$ V, Figure 11	2.5 to 4.4	126	-	400	$\mu\text{s}$
$O_{IRR}$	Off Isolation (Note 5)	$R_L = 50$ $\Omega$ , $f = 240$ MHz, Figure 13	2.5 to 4.4	-	-40	-	dB
$X_{talk}$	Channel-to-Channel Crosstalk (Note 5)	$R_L = 50$ $\Omega$ , $f = 240$ MHz, Figure 14	2.5 to 4.4	-	-40	-	dB
$t_{SK(P)}$	Pulse Skew (Note 5)	$V_{SW} = 0.2$ V diff <sub>PP</sub> , Figure 10, $C_L = 5$ pF	2.5 to 4.4	-	25	-	ps
$t_{SK(I)}$	Skew Between Differential Signals Within a Pair (Note 5)	$V_{SW} = 0.2$ V diff <sub>PP</sub> , Figure 10, $C_L = 5$ pF	2.5 to 4.4	-	25	-	ps

5. Guaranteed by characterization.

# FSUSB74

## CAPACITANCE CHARACTERISTICS (All typical values are for $V_{CC} = 3.3\text{ V}$ at $T_A = 25^\circ\text{C}$ unless otherwise specified.)

Symbol	Parameter	Test Conditions	$V_{CC}$ (V)	Typical	Unit
$C_{IN}$	Input Capacitance (Note 6)		0	3	pF
$C_{ON}$	D+/D- On Capacitance (Note 6)	Any Switch Path Enabled, $f = 1\text{MHz}$ , Figure 16	3.3	7.5	
$C_{OFF}$	HSD0n, HSD1n, HSD2n, HSD3n Off Capacitance (Note 6)	If $V_{CC} = 3.3\text{ V}$ , then $/OE = 3.3\text{ V}$ ; $f = 1\text{MHz}$ , Figure 15	0 or 3.3	2.2	

6. Guaranteed by characterization.

TEST DIAGRAMS

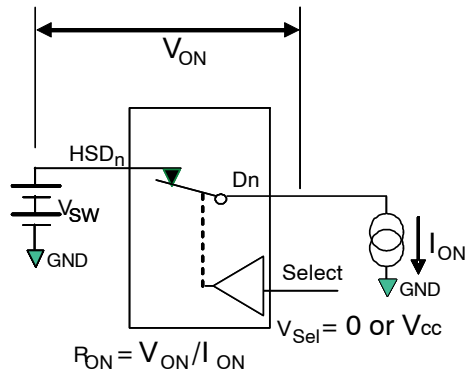
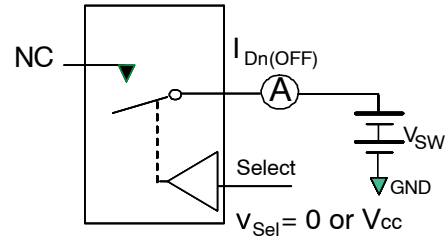


Figure 5. On Resistance



\*\*Each switch port is tested separately

Figure 6. Off Leakage

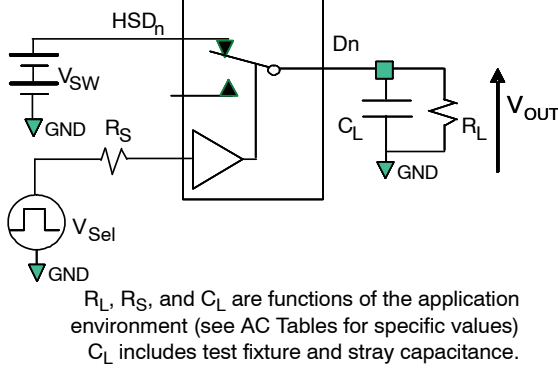


Figure 7. AC Test Circuit Load

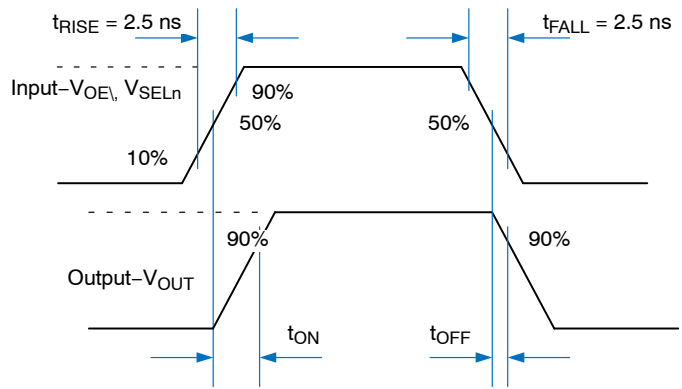


Figure 8. Turn-On / Turn-Off Waveforms

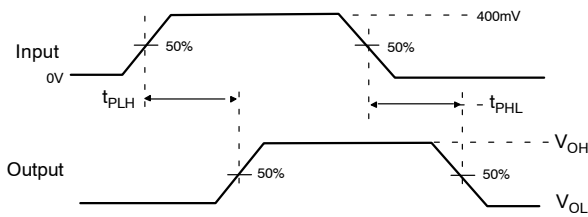


Figure 9. Propagation Delay ( $t_R$   $t_F$  = 500 ps)

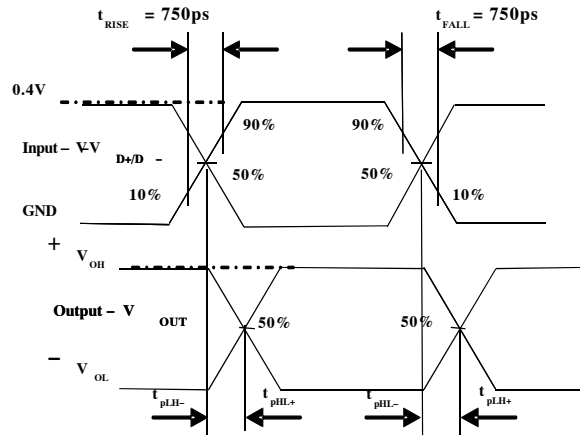
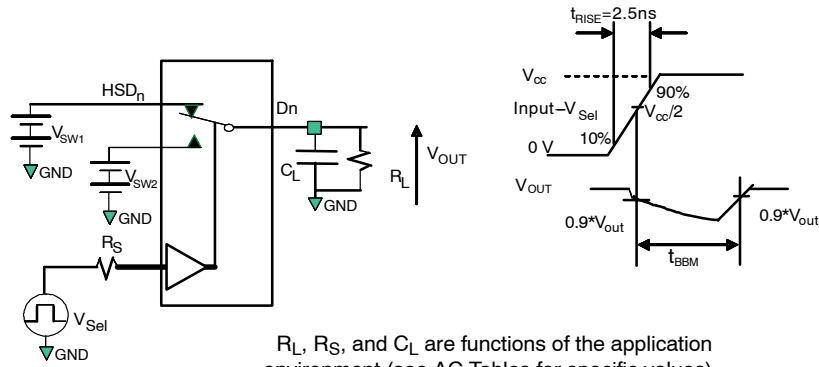


Figure 10. Skew Test Waveforms

$$t_{SK(P)} = |t_{PLH-} - t_{PHL-}| \text{ or } |t_{PLH+} - t_{PHL+}|$$

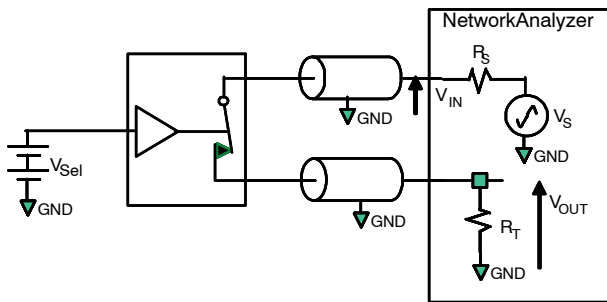
$$t_{SK(I)} = |t_{PLH-} - t_{PHL+}| \text{ or } |t_{PLH+} - t_{PHL-}|$$

TEST DIAGRAMS



$R_L$ ,  $R_S$ , and  $C_L$  are functions of the application environment (see AC Tables for specific values)  
 $C_L$  includes test fixture and stray capacitance.

Figure 11. Break-Before-Make Interval Timing



$R_S$ ,  $R_T$ , and are functions of the application environment (see AC Tables for specific values)

Figure 12. Bandwidth

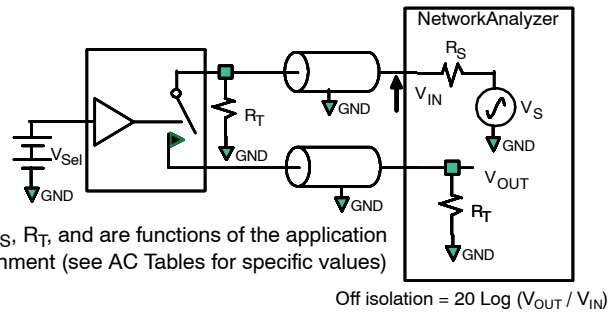


Figure 13. Channel Off Isolation

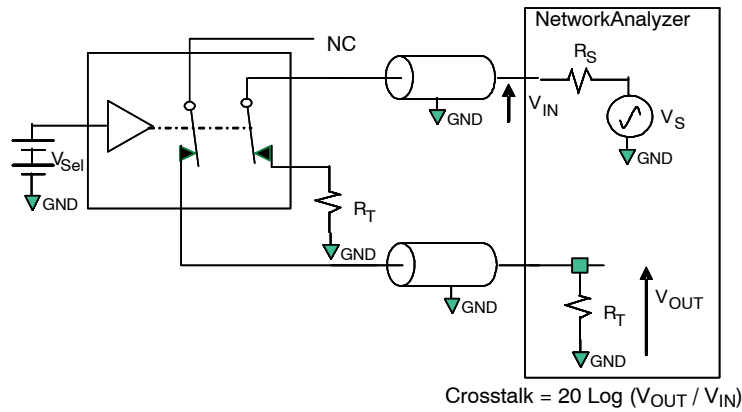


Figure 14. Non-Adjacent Channel-to-Channel Crosstalk

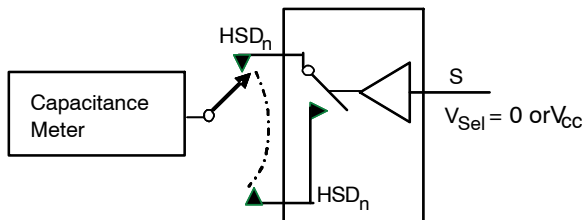


Figure 15. Channel Off Capacitance

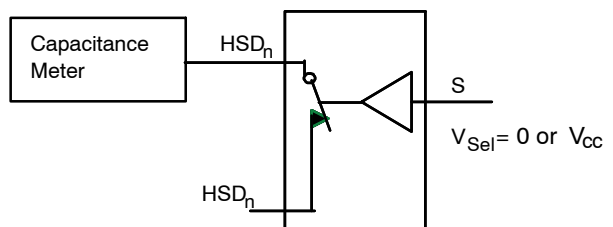
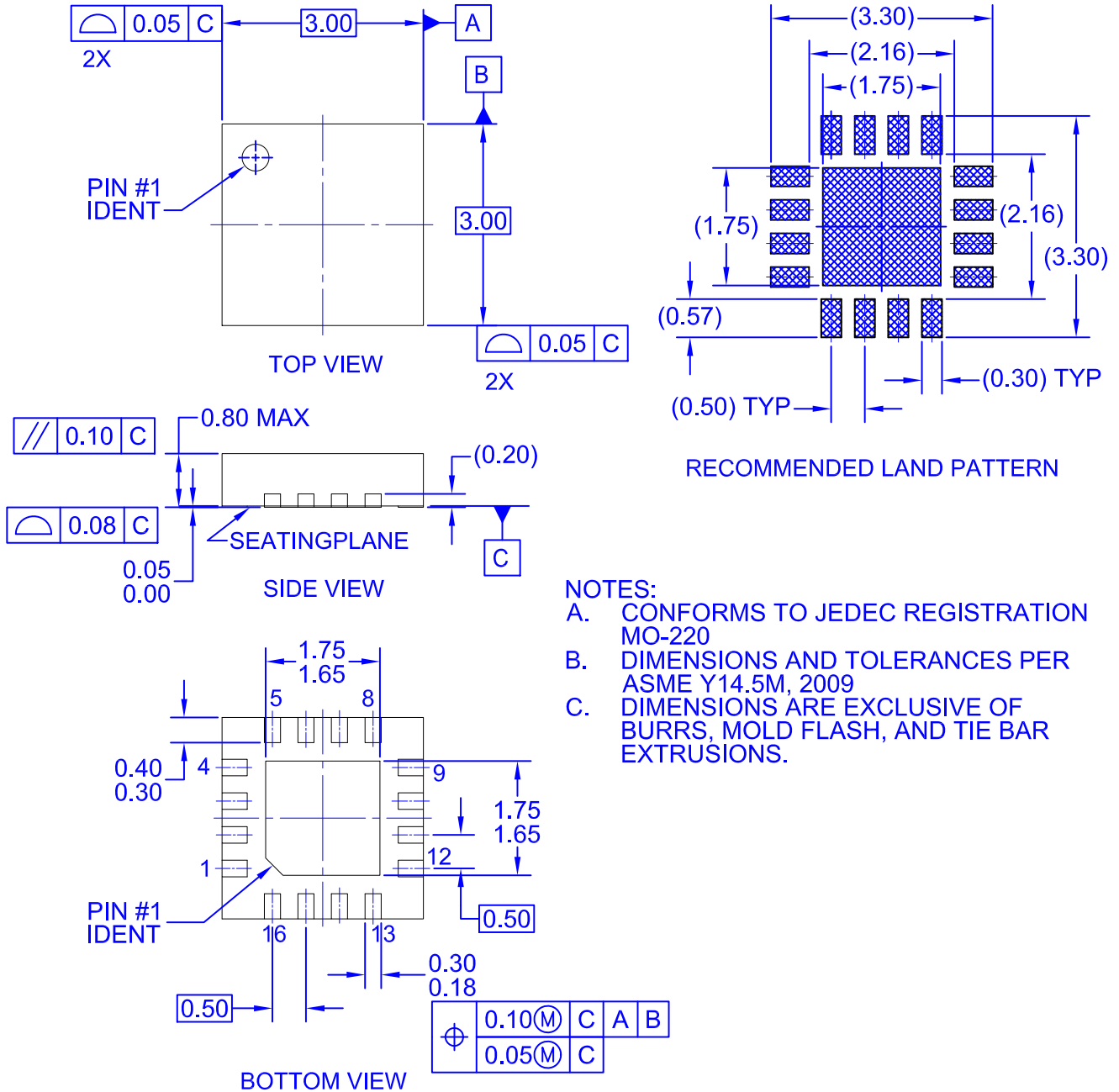


Figure 16. Channel On Capacitance

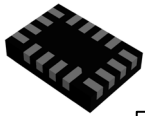
**WQFN16 3x3, 0.5P**  
CASE 510BS  
ISSUE O

DATE 31 AUG 2016



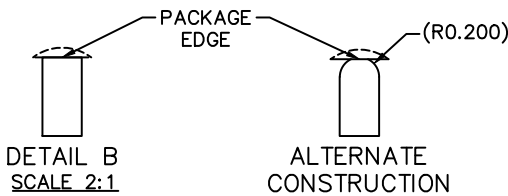
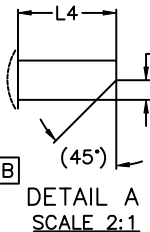
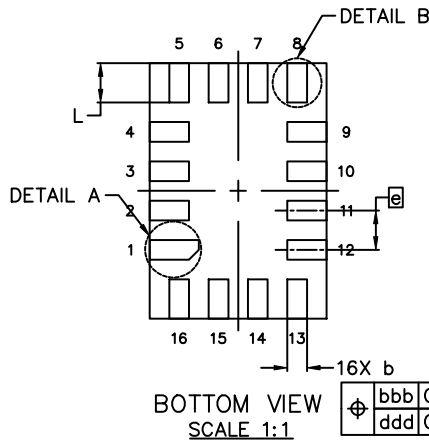
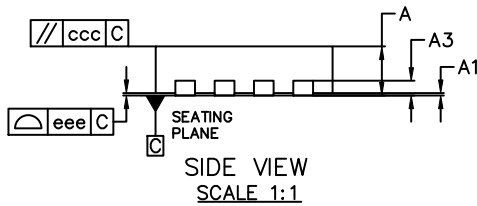
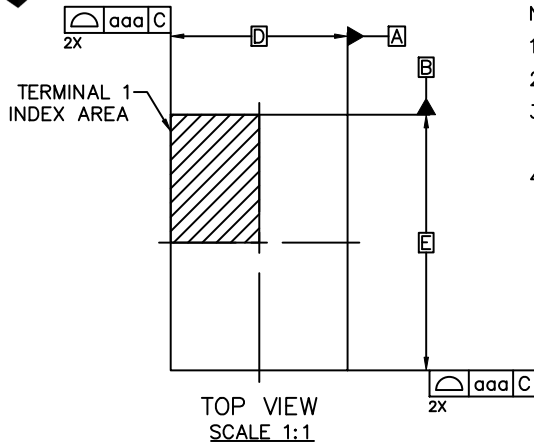
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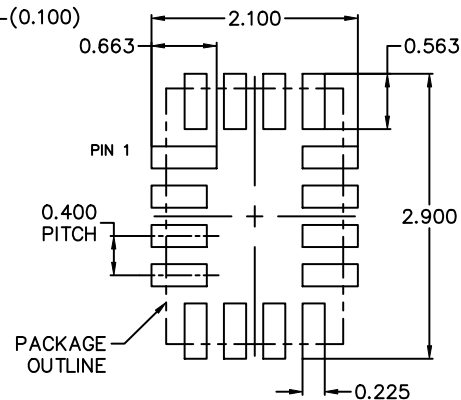


**UQFN-16 1.80x2.60x0.50, 0.40P**  
CASE 523BF  
ISSUE B

DATE 18 JUN 2026



DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.450	0.500	0.550
A1	0.000	0.025	0.050
A3	0.100	0.150	0.200
b	0.150	0.200	0.250
D	1.800 BSC		
E	2.600 BSC		
e	0.400 BSC		
L	0.350	0.400	0.450
L4	0.450	0.500	0.550
TOLERANCES FOR FEATURE CONTROL FRAME			
aaa	0.050		
bbb	0.100		
ccc	0.100		
ddd	0.050		
eee	0.050		



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